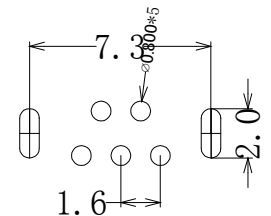
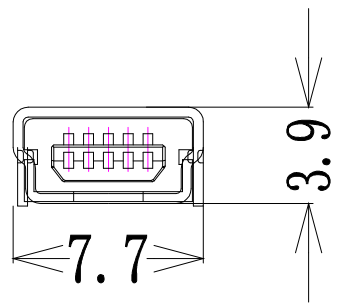
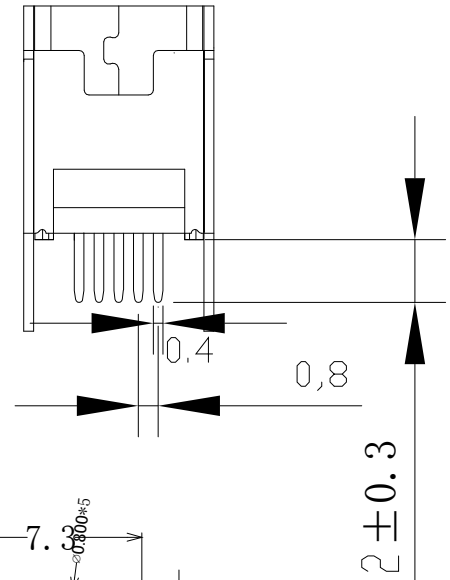
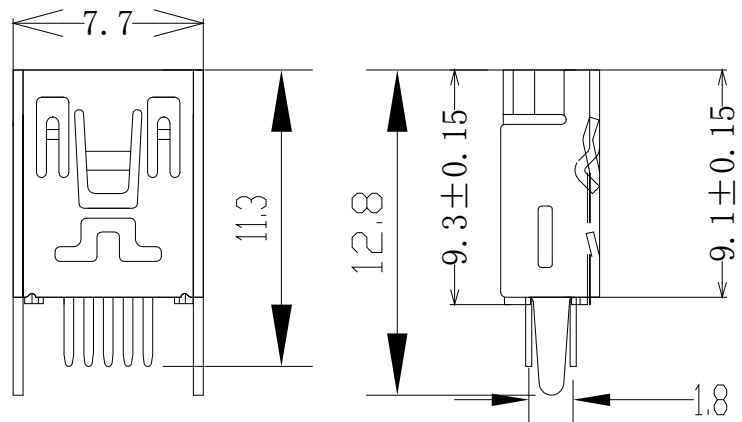


更改 REV	数量内容 MODIFICATION
A	EC07205
B	EC08829



Recommended PCB Layout

Specifications:
Electrical:
 Contact Resistance: 30 milliohms Max.
 Dielectric Withstanding Voltage: 500V AC Sea Level.
 Insulation Resistance: 100 MEGA ohms MIN.
Material:
 Housing: High Temperature Thermoplastics.
 Contact: Copper Alloy.
 Shell: Copper Alloy.
Finish:
 Contact: Plated Gold 1U" In Mating Area.
 Tin On Solder Tails.
 Shell: Nickel/Plating.

GENERAL TOLERANCE		KINGCONN 皇海科技股份有限公司	
X ± 0.50	X* ± 5 °	名 称(TITLE) MINI USB 180 DIP 2.5mm	
.X ± 0.30	.X* ± 2 °		
.XX ± 0.20	.XX* ± 1 °		
单 位(UNIT) mm	料 号(PART NO.) 7MNSB-F0-0036	图 号(DWG NO.) 7MNSB-F0-0036	
审 核(APPROVAL)	核 对(CHECKED)	制 图(DRAWN)	比 例(SCALE) 1:1
			张 数(SHEET) 1/1
			更 改(REV) B

